



SPECIFICATION FOR LCM MODULE

MODULE NO.: ABG128064A15-BIW-R
DOC. REVISION 00

Customer Approval:

--

	SIGNATURE	DATE
PREPARED BY (RD ENGINEER)		
PREPARED BY (QA ENGINEER)		
CHECKED BY		
APPROVED BY		



DOCUMENT REVISION HISTORY

Version	DATE	DESCRIPTION	CHANGED BY
00	Mar-19-2007	First issue	



CONTENTS

1. Functions & Features	1
2. Mechanical specifications	1
3. Block diagram	1
4. Dimensional Outline	2
5. Pin description	3
6. Maximum absolute limit	3
7. Electrical characteristics	4
8. Backlight Characteristics	4
9. Electro-Optical characteristics	4/5
10. Timing Characteristics	6
11. Control and display command	7
12. Quality Specifications	7~16

1. FUNCTIONS & FEATURES

1.1. Format	: 128x64dots
1.2. LCD mode	: STN / Negative Transmissive Mode /Blue
1.3. Viewing direction	: 6 o'clock
1.4. Driving scheme	: 1/64 Duty cycle, 1/6 Bias
1.5. Power supply voltage (V _{DD})	: 5.0V
1.6. LCD driving voltage	: 8.0V
1.7. Operation temp	: -20~70°C
1.8. Storage temp	: -30~80°C
1.9. Backlight color	: White
1.10. Control IC	: S6B0108B
1.11. RoHS standard	

2. MECHANICAL SPECIFICATIONS

2.1. Module size	: 93.0mm(L)*70.0mm(W)*13.8 max mm (H)
2.2. Viewing area	: 70.7mm(L)*38.8mm(W)
2.3. Dot pitch	: 0.52mm(L)*0.52mm(W)
2.4. Dot size	: 0.48mm(L)*0.48mm(W)
2.5. Weight	: Approx.

3. BLOCK DIAGRAM

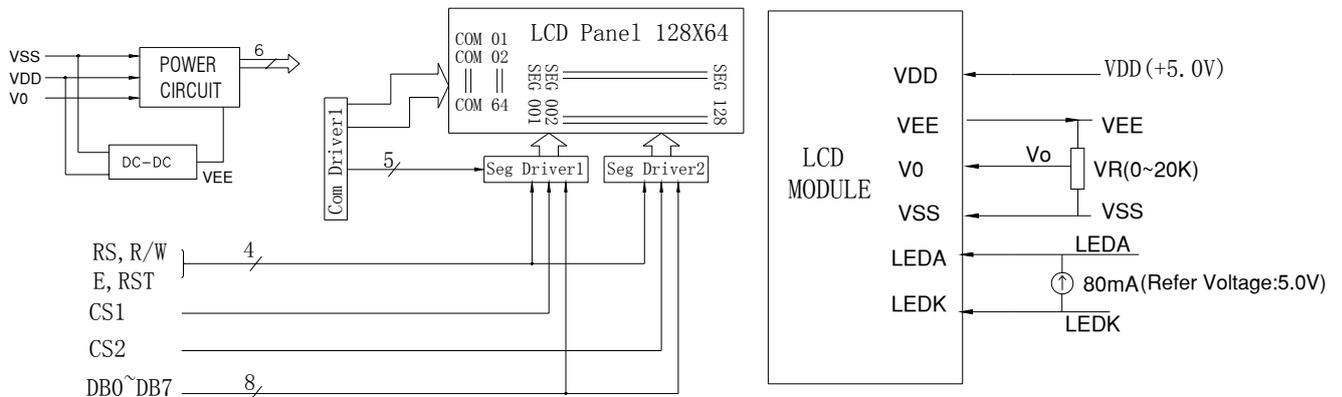


Figure 1. Block diagram

4. DIMENSIONAL OUTLINE

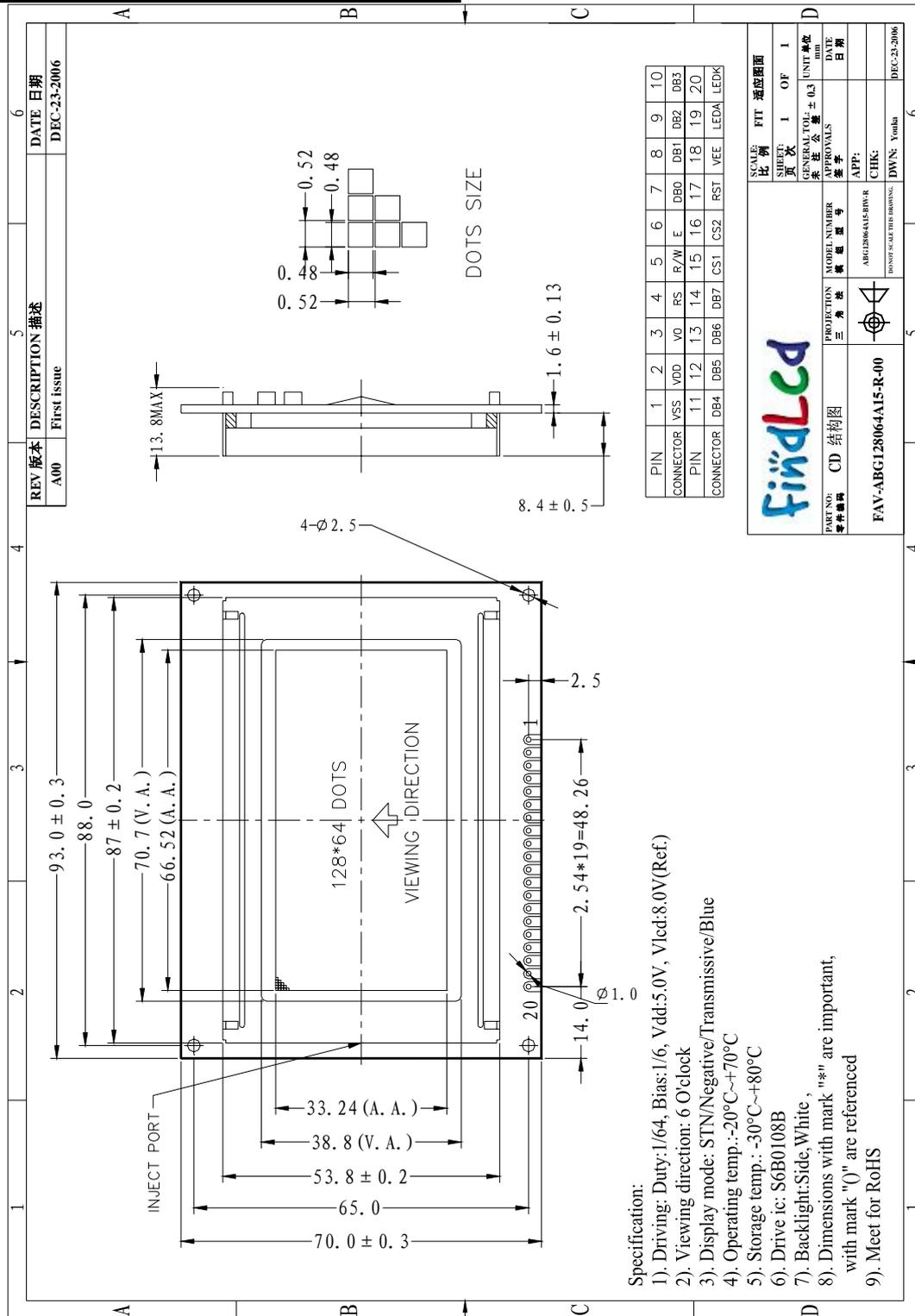
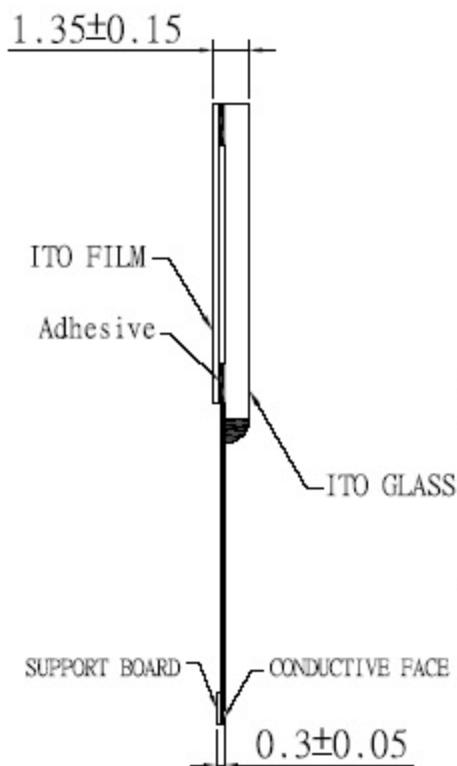
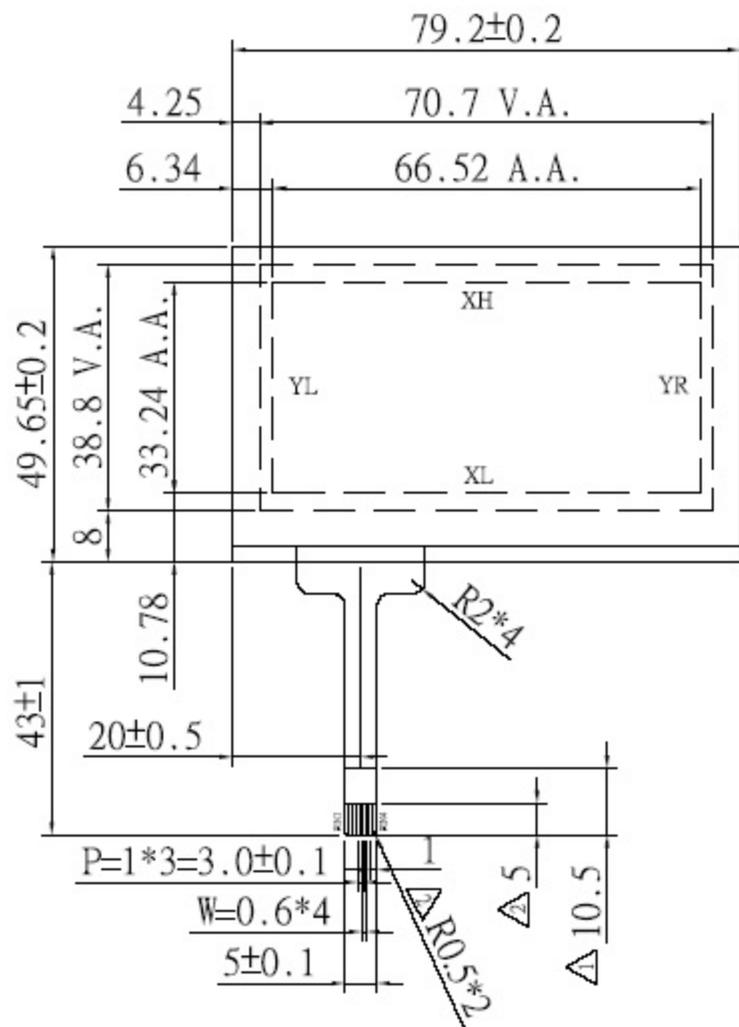


Figure 1. Dimensional outline

CUSTOMER CORD	CUSTOMER NAME	NO.	Revision Record	Reviser	Date
CUSTOMER'S APPROVAL	CUSTOMER'S BY	1.	△ 修改位置與尺寸	Matthew	05/09/01
		2.	△ 修改FPC尺寸	Matthew	05/12/22
		3.			



CIRCUIT DIAGRAM		PIN OUT	
		PIN	DESC
		1	XH
2	YL		
3	XL		
4	YR		

		SPECIFICATIONS	MEASURING SPEC
Optical Spec	Transmittance	78% or more	Anti-Clare Type
Electrical Spec	1. Resistance between Lead	Direction "X" (Flim): 200~900Ω Direction "Y" (Glass): 200~900Ω	
	2. Linearity	Direction "X": 1.5% or less Direction "Y": 1.5% or less	
	3. Insulation R	20MΩ or more at DC 25V	
	4. Chattering Time	10msec or less at 100kΩ pull-up	
Mechanical Spec	1. Input Method	A Special Stylus or Finger	
	2. Operating Force	Stylus: 80g or less (R0.8 Polyacetal Pen) Finger: 80g or less (R8.0 HS40° Silicon Rubber)	
	3. Surface Hardness	3H or more (according to JIS-K5400)	
Reliability	1. High Temp Test	80°C for 240 hours in vessel	After 24 hours, measure it & satisfy Electrical Spec 1,2,3.
	2. Low Temp Test	-40°C for 240 hours in vessel	
	3. Temp&Humidity Test	60°C, 90%RH for 240 hours in vessel	
	4. Thermal Shock Test	-30°C for 60min & 80°C for 60min (20 cycles)	
Durability	1. Hand Writing Friction Resistance	Write 120000 capital in 20mmX20mm (force: 250g, speed: 1000 characters/hour)	measure it & satisfy Electrical Spec 1,2,3.
	2. Punching Life	Punch 100000 times with R0.8silicon rubber (force: 250g, speed: 2/sec)	
	3. FPC Peeling Strength	400g/cm or more (peeling upward by 90° in direction of X, speed: 50mm/min)	

Elucidation	總成圖	Drive Model	Analog	Approved By	蔡明樹	05 / 07 / 21	www.FindLCD.com Gemini Technology Co., Ltd. Tel : 031-455-3200. Fax: 031-429-7097				Pro (3)	
Panel Size	79.2X 49.65mm	Drive Voltage		Checked By	蔡明樹	05 / 07 / 21					Model Number	
Viewing Size	70.7X38.8 mm	Operating Temp	-20~60°C	Design By	X.W.H	05 / 07 / 21	Drawing Number		PQ070XRA03			
Front Material/Thickness	Transparent Pet(3H)/0.188mm	Storage Temp	-40~60°C	Drawing By	X.W.H	05 / 07 / 21	Sheet	1/1	Tolerance	±0.2	Unit	mm
Rear Material/Thickness	Glass / 1.1mm	Connector	FPC(Polyimide)	Data Reserve	D:\DWG\GPQ070XRA\GPQ070XRA.DWG		Size	A4	Angles	±0.5°	Scale	

5. PIN DESCRIPTION

No.	Symbol	Function
1	VSS	GND
2	VDD	Logic supply voltage (+5.0V)
3	V0	Power supply for LCD
4	RS	Data/Instruction RS=high: Indicates that data of DB0~DB7 is display data. RS=low: Indicates that data of DB0~DB7 is instruction
5	R/W	Read/Write R/W=high : Data of DB0~DB7 can be read by CPU. R/W=low: Data of DB0~DB7 can be written into LCD driver IC at the falling edge of E when CS1 and CS2 is high.
6	E	Enable signal for LCM
7~14	DB0-DB7	Data Bus line
15	CS1	Chip select(High select left panel)
16	CS2	Chip select(High select right panel)
17	RST	Reset Signal, low level of RST is for reset and keep RST='h'
18	VEE	Output of supply negative voltage by the DC-DC converter on the module
19	LEDA	Power supply for backlight(+)
20	LEDK	Power supply for backlight(-)

6. MAXIMUM ABSOLUTE LIMIT

Item	Symbol	MIN	MAX	Unit
Supply Voltage for Logic	V _{DD}	-0.3	7.0	V
Supply Voltage for LCD	V ₀	V _{DD} -19.0	V _{DD} +0.3	V
Input Voltage	V _{in}	-0.3	V _{DD} +0.3	V
Supply Current for Backlight	I _F (Ta = 25°C)	---	80+80*20%	mA
Reverse Voltage for Backlight	V _R (Ta = 25°C)	---	5	V
Operating Temperature	Top	-20	70	°C
Storage Temperature	Tst	-30	80	°C

7. ELECTRICAL CHARACTERISTICS

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage for Logic	V _{DD-VSS}	Ta = 25°C	4.75	5.0	5.25	V
Input High Voltage	V _{IH}	Ta = 25°C	0.7V _{DD}	---	V _{DD}	V
Input Low Voltage	V _{IL}	Ta = 25°C	0	---	0.3V _{DD}	V
Output High Voltage	V _{OH}	Ta = 25°C	2.4	---	---	V
Output Low Voltage	V _{OL}	Ta = 25°C	---	---	0.4	V
Supply Current	I _{DD}	Ta = 25°C	---	5	8	mA

8. BACKLIGHT CHARACTERISTICS

Ta = 25°C

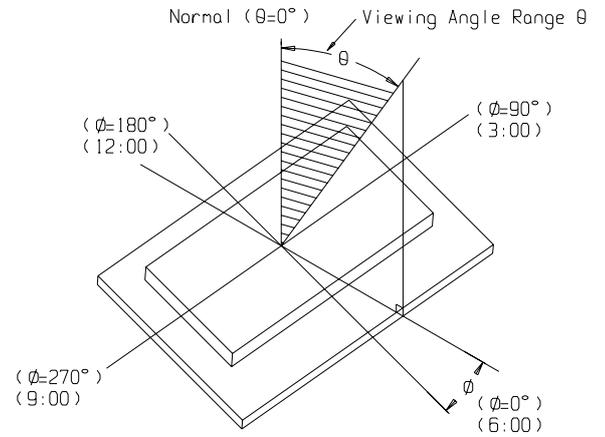
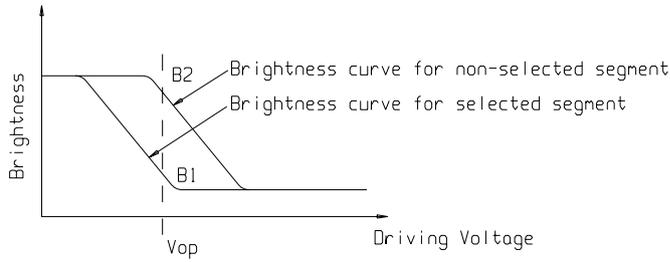
Item	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	V _F	I _F =80mA	3.0	3.1	3.2	V
Reverse Current	I _R	V _R =5V	---	---	40	uA
Luminous Intensity (With LCD dots off)	I _V	I _F =80mA	---	50	---	Cd/m ²
Wave length(Without LCD)	λ _p		---	---	---	nm
Color			white			

9. ELECTRO-OPTICAL CHARACTERISTICS

(V_{DD}=5.0V, Ta = 25°C)

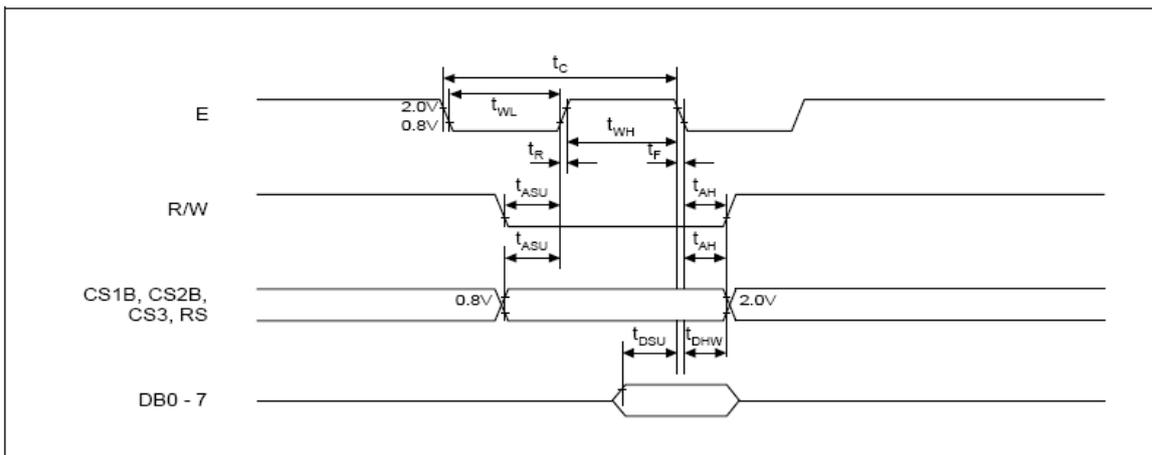
Item	Symbol	Condition	Min	Typ	Max	Unit
Operating Voltage	V _{op}	Ta = -20C	8.2	8.5	8.8	V
		Ta = 25°C	7.7	8.0	8.3	
		Ta = 70C	7.2	7.5	7.8	
Response time	T _r	Ta = 25°C	---	185	---	ms
	T _f		---	200	---	ms
Contrast	C _r	Ta = 25°C	---	4	---	---
Viewing angle range	θ	C _r ≥2	-40	---	+40	deg
	Φ		-40	---	+40	deg

$$Cr = \frac{\text{Brightness of non-selected segment}(B2)}{\text{Brightness of selected segment}(B1)}$$

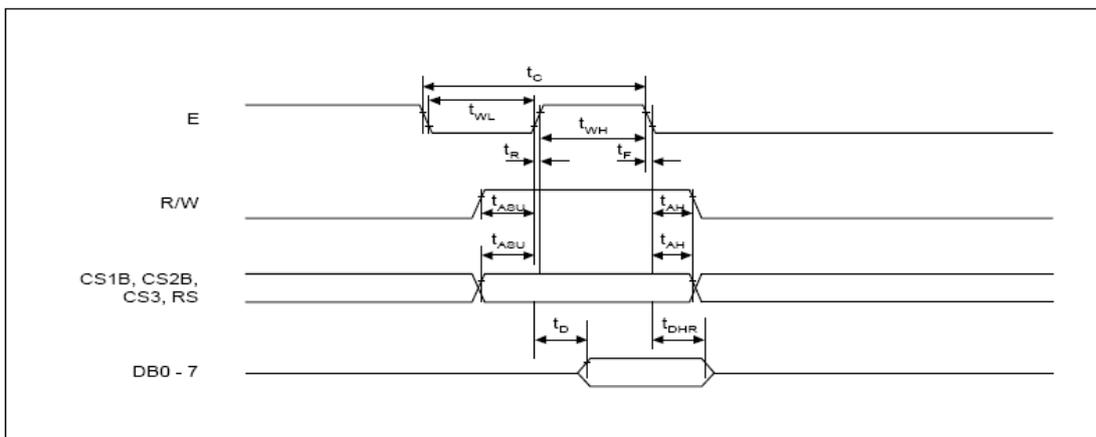


10. TIMING CHARACTERISTICS (Please refer SAMSUNG S6B0108 DATASHEETS)

Characteristic	Symbol	Min	Typ	Max	Unit
E cycle	t_C	1000	-	-	ns
E high level width	t_{WH}	450	-	-	ns
E low level width	t_{WL}	450	-	-	ns
E rise time	t_R	-	-	25	ns
E fall time	t_F	-	-	25	ns
Address set-up time	t_{ASU}	140	-	-	ns
Address hold time	t_{AH}	10	-	-	ns
Data set-up time	t_{DSU}	200	-	-	ns
Data delay time	t_D	-	-	320	ns
Data hold time (write)	t_{DHW}	10	-	-	ns
Data hold time (read)	t_{DHR}	20	-	-	ns



MPU write timing



MPU read timing

11. CONTROL AND DISPLAY INSTRUCTION (Please refer SAMSUNG S6B0108 DATASHEES)

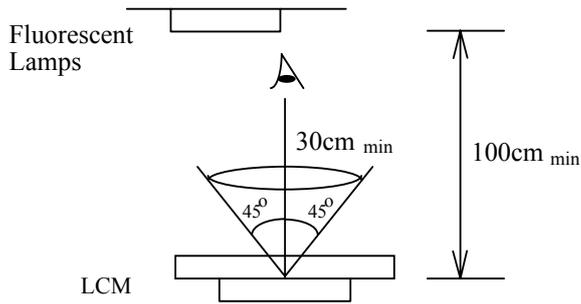
Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Function	
Display on/off	L	L	L	L	H	H	H	H	H	L/H	Controls the display on or off. Internal status and display RAM data is not affected. L: OFF, H: ON	
Set address (Y address)	L	L	L	H	Y address (0 - 63)						Sets the Y address in the Y address counter.	
Set page (X address)	L	L	H	L	H	H	H	Page (0 - 7)			Sets the X address at the X address register.	
Display start line (Z address)	L	L	H	H	Display start line (0 - 63)						Indicates the display data RAM displayed at the top of the screen.	
Status read	L	H	Busy	L	On / Off	Reset	L	L	L	L	Read status. BUSY L: Ready H: In operation ON/OFF L: Display ON H: Display OFF RESET L: Normal H: Reset	
Write display data	H	L	Write data									Writes data (DB0:7) into display data RAM. After writing instruction, Y address is increased by 1 automatically.
Read display data	H	H	Read data									Reads data (DB0: 7) from display data RAM to the data bus.

12.QUALITY SPECIFICATIONS

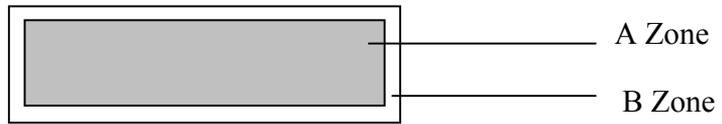
12.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: Active display area (minimum viewing area).

B Zone: Non-active display area (outside viewing area).

12.2 Specification of quality assurance

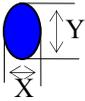
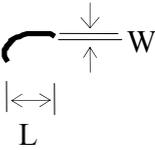
AQL inspection standard

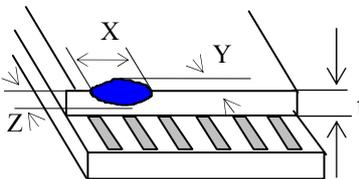
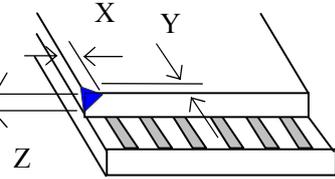
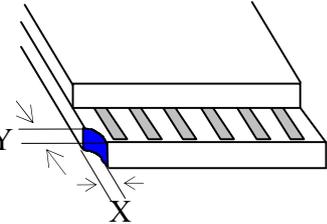
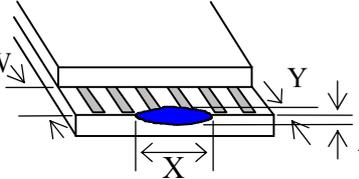
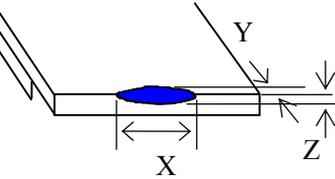
Sampling method: MIL-STD-105E, Level II, single sampling

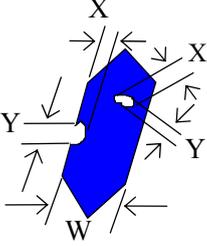
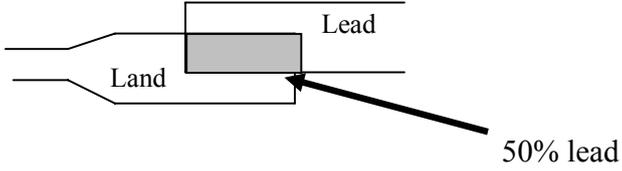
Defect classification (**Note: * is not including**)

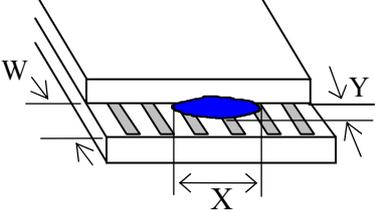
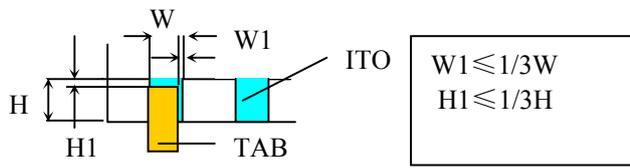
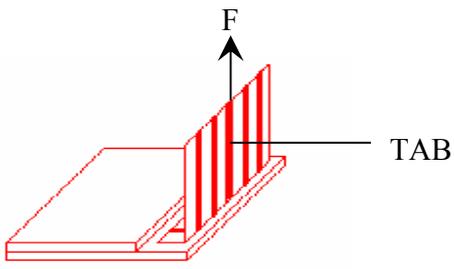
Classify	Item		Note	AQL
Major	Display state	Short or open circuit	1	0.65
		LC leakage		
		Flickering		
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
Wrong or missing component		11		
Minor	Display state	Background color deviation	2	1.0
		Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
	Polarizer	Protruded	12	
		Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	

Note on defect classification

No.	Item	Criterion																				
1	Short or open circuit	Not allow																				
	LC leakage																					
	Flickering																					
	No display																					
	Wrong viewing direction																					
	Wrong Back-light																					
2	Contrast defect	Refer to approval sample																				
	Background color deviation																					
3	Point defect, Black spot, dust (including Polarizer) $\phi = (X+Y)/2$	 <table border="1" data-bbox="917 994 1342 1283"> <thead> <tr> <th>Point Size</th> <th>Acceptable Qty.</th> </tr> </thead> <tbody> <tr> <td>$\phi \leq 0.10$</td> <td>Disregard</td> </tr> <tr> <td>$0.10 < \phi \leq 0.20$</td> <td>3</td> </tr> <tr> <td>$0.20 < \phi \leq 0.25$</td> <td>2</td> </tr> <tr> <td>$0.25 < \phi \leq 0.30$</td> <td>1</td> </tr> <tr> <td>$\phi > 0.30$</td> <td>0</td> </tr> </tbody> </table> <p>Unit: mm</p>	Point Size	Acceptable Qty.	$\phi \leq 0.10$	Disregard	$0.10 < \phi \leq 0.20$	3	$0.20 < \phi \leq 0.25$	2	$0.25 < \phi \leq 0.30$	1	$\phi > 0.30$	0								
Point Size	Acceptable Qty.																					
$\phi \leq 0.10$	Disregard																					
$0.10 < \phi \leq 0.20$	3																					
$0.20 < \phi \leq 0.25$	2																					
$0.25 < \phi \leq 0.30$	1																					
$\phi > 0.30$	0																					
4	Line defect, Scratch	 <table border="1" data-bbox="847 1451 1382 1704"> <thead> <tr> <th colspan="2">Line</th> <th>Acceptable Qty.</th> </tr> <tr> <th>L</th> <th>W</th> <th></th> </tr> </thead> <tbody> <tr> <td>---</td> <td>$0.015 \geq W$</td> <td>Disregard</td> </tr> <tr> <td>$5.0 \geq L$</td> <td>$0.03 \geq W$</td> <td rowspan="2">2</td> </tr> <tr> <td>$5.0 \geq L$</td> <td>$0.05 \geq W$</td> </tr> <tr> <td>$5.0 \geq L$</td> <td>$0.1 > W$</td> <td>1</td> </tr> <tr> <td>---</td> <td>$0.05 < W$</td> <td>Applied as point defect</td> </tr> </tbody> </table> <p>Unit: mm</p>	Line		Acceptable Qty.	L	W		---	$0.015 \geq W$	Disregard	$5.0 \geq L$	$0.03 \geq W$	2	$5.0 \geq L$	$0.05 \geq W$	$5.0 \geq L$	$0.1 > W$	1	---	$0.05 < W$	Applied as point defect
Line		Acceptable Qty.																				
L	W																					
---	$0.015 \geq W$	Disregard																				
$5.0 \geq L$	$0.03 \geq W$	2																				
$5.0 \geq L$	$0.05 \geq W$																					
$5.0 \geq L$	$0.1 > W$	1																				
---	$0.05 < W$	Applied as point defect																				
5	Rainbow	Not more than two color changes across the viewing area.																				

No	Item	Criterion							
6	Chip Remark: X: Length direction Y: Short direction Z: Thickness direction t: Glass thickness W: Terminal Width	 <p>Acceptable criterion</p> <table border="1"> <thead> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>≤ 2</td> <td>0.5mm</td> <td>$\leq t/2$</td> </tr> </tbody> </table>	X	Y	Z	≤ 2	0.5mm	$\leq t/2$	
		X	Y	Z					
		≤ 2	0.5mm	$\leq t/2$					
		 <p>Acceptable criterion</p> <table border="1"> <thead> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>≤ 3</td> <td>0.5mm</td> <td>$\leq t$</td> </tr> </tbody> </table>	X	Y	Z	≤ 3	0.5mm	$\leq t$	
		X	Y	Z					
≤ 3	0.5mm	$\leq t$							
 <p>Acceptable criterion</p> <table border="1"> <thead> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>≤ 3</td> <td>≤ 2</td> <td>$\leq t$</td> </tr> <tr> <td colspan="2">shall not reach to ITO</td> <td></td> </tr> </tbody> </table>	X	Y	Z	≤ 3	≤ 2	$\leq t$	shall not reach to ITO		
X	Y	Z							
≤ 3	≤ 2	$\leq t$							
shall not reach to ITO									
 <p>Acceptable criterion</p> <table border="1"> <thead> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>Disregard</td> <td>≤ 0.2</td> <td>$\leq t$</td> </tr> </tbody> </table>	X	Y	Z	Disregard	≤ 0.2	$\leq t$			
X	Y	Z							
Disregard	≤ 0.2	$\leq t$							
 <p>Acceptable criterion</p> <table border="1"> <thead> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>≤ 5</td> <td>≤ 2</td> <td>$\leq t/3$</td> </tr> </tbody> </table>	X	Y	Z	≤ 5	≤ 2	$\leq t/3$			
X	Y	Z							
≤ 5	≤ 2	$\leq t/3$							

No.	Item	Criterion								
7	Segment pattern $W = \text{Segment width}$ $\phi = (X+Y)/2$	(1) Pin hole $\phi < 0.10\text{mm}$ is acceptable.  <table border="1" data-bbox="906 584 1358 757"> <thead> <tr> <th>Point Size</th> <th>Acceptable Qty</th> </tr> </thead> <tbody> <tr> <td>$\phi \leq 1/4W$</td> <td>Disregard</td> </tr> <tr> <td>$1/4W < \phi \leq 1/2W$</td> <td>1</td> </tr> <tr> <td>$\phi > 1/2W$</td> <td>0</td> </tr> </tbody> </table> <p style="text-align: center;">Unit: mm</p>	Point Size	Acceptable Qty	$\phi \leq 1/4W$	Disregard	$1/4W < \phi \leq 1/2W$	1	$\phi > 1/2W$	0
Point Size	Acceptable Qty									
$\phi \leq 1/4W$	Disregard									
$1/4W < \phi \leq 1/2W$	1									
$\phi > 1/2W$	0									
8	Back-light	(1) The color of backlight should correspond its specification. (2) Not allow flickering								
9	Soldering	(1) Not allow heavy dirty and solder ball on PCB. (The size of dirty refer to point and dust defect) (2) Over 50% of lead should be soldered on Land. 								
10	Wire	(1) Copper wire should not be rusted (2) Not allow crack on copper wire connection. (3) Not allow reversing the position of the flat cable. (4) Not allow exposed copper wire inside the flat cable.								
11*	PCB	(1) Not allow screw rust or damage. (2) Not allow missing or wrong putting of component.								

No	Item	Criterion
12	Protruded W: Terminal Width	 <p>Acceptable criteria: $Y \leq 0.4$</p>
13	TAB	<p>1. Position</p>  <p>2. TAB bonding strength test</p>  <p>$P (=F/\text{TAB bonding width}) \geq 650\text{gf/cm}$,(speed rate: 1mm/min) 5pcs per SOA (shipment)</p>
14	Total no. of acceptable Defect	<p>A. Zone</p> <p>Maximum 2 minor non-conformities per one unit. Defect distance: each point to be separated over 10mm</p> <p>B. Zone</p> <p>It is acceptable when it is no trouble for quality and assembly in customer's end product.</p>

12.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	80°C	48	No abnormalities in functions and appearance
High temp. Operating	70°C	48	
Low temp. Storage	-30°C	48	
Low temp. Operating	-20°C	48	
Humidity	40°C/ 90%RH	48	
Temp. Cycle	-20°C ← 25°C → 70°C (30 min ← 5 min → 30min)	10cycles	

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance ,etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ($20 \pm 8^\circ\text{C}$), normal humidity (below $45 \pm 20\%$ RH), and in the area not exposed to direct sun light.

12.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isopropyl alcohol, ethyl alcohol or trichlorotrifluoroethane, do not use water, ketone or aromatics and never scrub hard.
3. Do not tamper in any way with the tabs on the metal frame.
4. Do not make any modification on the PCB without consulting Gemini.
5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.

6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
5. Only properly grounded soldering irons should be used.
6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
7. The normal static prevention measures should be observed for work clothes and working benches.
8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

1. Soldering should be performed only on the I/O terminals.
2. Use soldering irons with proper grounding and no leakage.
3. Soldering temperature: $280^{\circ}\text{C} \pm 10^{\circ}\text{C}$
4. Soldering time: 3 to 4 second.
5. Use eutectic solder with resin flux filling.
6. If flux is used, the LCD surface should be protected to avoid spattering flux.
7. Flux residue should be removed.

Operation Precautions:

1. The viewing angle can be adjusted by varying the LCD driving voltage V_o .
2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
4. Response time increases with decrease in temperature.
5. Display color may be affected at temperatures above its operational range.
6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty

Gemini LCDs and modules are not consumer products, but may be incorporated by Gemini's customers into consumer products or components thereof, Gemini does not warrant that its LCDs and components are fit for any such particular purpose.

1. The liability of Gemini is limited to repair or replacement on the terms set forth below. Gemini will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between Gemini and the customer, Gemini will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with Gemini general LCD inspection standard . (Copies available on request)
2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.